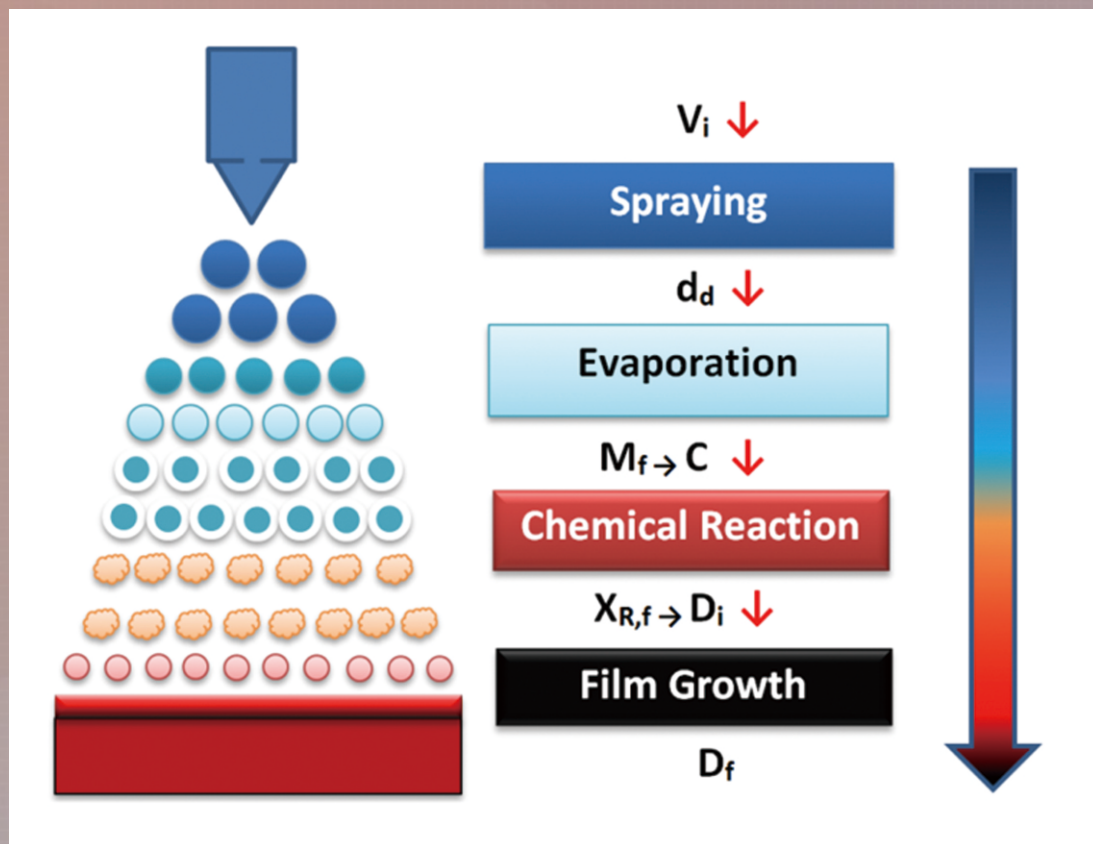


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ISSN 2153-117X (Print) ISSN 2153-1188 (Online)

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